

**PATENT ASSIGNMENT**

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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
<b>CONVEYING PARTY DATA</b>											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Yuuji IWAKIRI</td> <td>06/15/2009</td> </tr> <tr> <td>Taketoshi MANOU</td> <td>06/15/2009</td> </tr> <tr> <td>Tsuneo IMATANI</td> <td>06/15/2009</td> </tr> <tr> <td>Hideto MONZEN</td> <td>06/15/2009</td> </tr> </tbody> </table>		Name	Execution Date	Yuuji IWAKIRI	06/15/2009	Taketoshi MANOU	06/15/2009	Tsuneo IMATANI	06/15/2009	Hideto MONZEN	06/15/2009
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<b>RECEIVING PARTY DATA</b>											
Name:	Toyo Seikan Kaisha, Ltd.										
Street Address:	3-1, Uchisaiwai-cho 1-chome, Chiyoda-ku										
City:	Tokyo										
State/Country:	JAPAN										
Postal Code:	100-8522										
<b>PROPERTY NUMBERS Total: 1</b>											
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>12520370</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	12520370						
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<b>CORRESPONDENCE DATA</b>											
Fax Number:	(703)716-1180										
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Total Attachments: 1 source=P36874_As#page1.tif											

OP \$40.00 12520370

**500891059**

**PATENT**  
**REEL: 022851 FRAME: 0025**

# Assignment

In consideration of One Dollar (\$1.00), and other good and valuable consideration, the receipt of which is hereby acknowledged, we, the undersigned, Yuuji IWAKIRI, Taketoshi MANOU, Tsuneo IMATANI and Hideto MONZEN, all citizen of Japan, residing respectively at Kanagawa, Japan, Kanagawa, Japan, Kanagawa, Japan and Kanagawa, Japan.

Hereby sell, assign and transfer to Toyo Seikan Kaisha, Ltd. a corporation of Japan having a place of business at 3-1, Uchisaiwai-cho 1-chome, Chiyoda-ku, Tokyo 100-8522, Japan its successors, assigns and legal representatives, the entire right, title and interest for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned concurrently herewith June 15, 2009, and is entitled Metal Mold for Compression Forming

, and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be issued in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Date: June 15, 2009

*Yuuji Iwakiri* ..... (L.S.)

*Taketoshi Manou* ..... (L.S.)

*Tsuneo Imatani* ..... (L.S.)

Witness

*Hideto Monzen* ..... (L.S.)

*Fukashi Kuriki* ..... (L.S.)

..... (L.S.)